

Description

The AONS21321 uses advanced trench technology excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as aload switch or in PWM applications.

General Features

$$\begin{split} V_{DS} &= -30 V, I_D = -50 A \\ R_{DS(ON)} &< 15 m \Omega @ V_{GS} = -10 V \\ R_{DS(ON)} &< 25 m \Omega @ V_{GS} = -4.5 V \end{split}$$

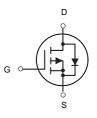
High Power and current handing capability Lead free product is acquired Surface mount package

Application

PWM applications Load switch Power management







P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
AONS21321	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

Symbol	Parameter	Limit	Unit	
VDS	Drain-Source Voltage	-30	V	
VGS	Gate-Source Voltage	±20	V	
_	Drain Current-Continuous (Tc=25 $^{\circ}$ C)	-50		
lD	Drain Current-Continuous (Tc=100℃)	-24	A	
IDM	Drain Current-Pulsed (Note 1)	-80	А	
_	Maximum Power Dissipation (T_c=25 $^\circ \!\! C$)	3		
PD	Maximum Power Dissipation (T_c=100 $^\circ\!\!\!\mathrm{C}$)	1.3	W	
EAS	Single pulse avalanche energy (Note 5)	231	mJ	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C	
RθJA	Thermal Resistance, Junction-to-Ambient (Note 2)	41.67	°C /W	

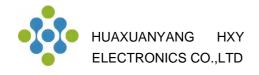


Electrical Characteristics (T_A=25 $^\circ\!\!\!{}^\circ\!\!\!{}^\circ\!\!\!{}^\circ$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	IGSS	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.5	-3	V
		V _{GS} =-10V, I _D =-10A	-	9	15	mΩ
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =-4.5V, I _D =-7A	-	18	25	mΩ
Forward Transconductance	gFS	V _{DS} =-10V,I _D =-10A	-	20	-	S
Input Capacitance	Clss		-	1750	-	PF
Output Capacitance	Coss	V _{DS} =-15V,V _{GS} =0V,	-	215	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	180	-	PF
Turn-on Delay Time	td(on)		-	9	-	nS
Turn-on Rise Time	tr	V _{DD} =-15V, ID=-10A,	-	8	-	nS
Turn-Off Delay Time	td(off)	V _{GS} =-10V,R _{GEN} =1Ω	-	28	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg		-	24	-	nC
Gate-Source Charge	Qgs	V _{DS} =-15V,I _D =-10A,V _{GS} =- 10V	-	3.5	-	nC
Gate-Drain Charge	Q _{gd}		-	6	-	nC
Diode Forward Current (Note 2)	ls		-	-	-12	А
Diode Forward Voltage (Note 3)	VSD	V _{GS} =0V,I _S =-12A	-	-	-1.2	V

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25°C, V_{DD} =-15V, V_G =10V, L=0.5mH, Rg=25 Ω , I_{AS} =-34A



Typical Electrical and Thermal Characteristics

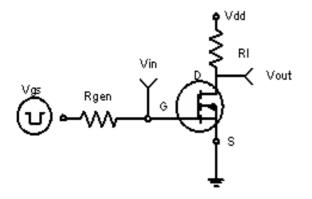
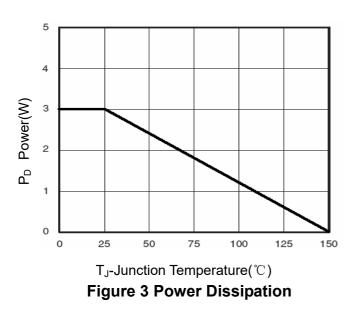
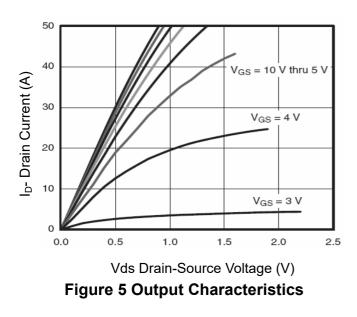


Figure 1:Switching Test Circuit





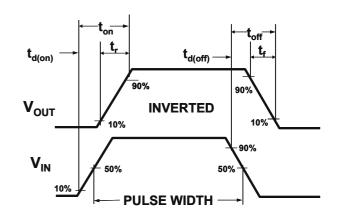


Figure 2:Switching Waveforms

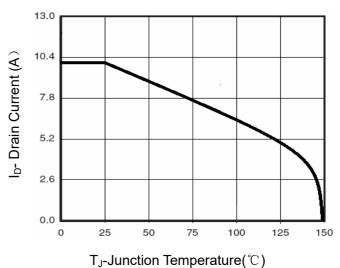


Figure 4 Drain Current

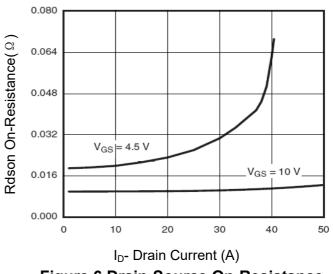


Figure 6 Drain-Source On-Resistance

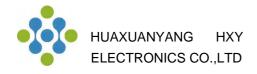
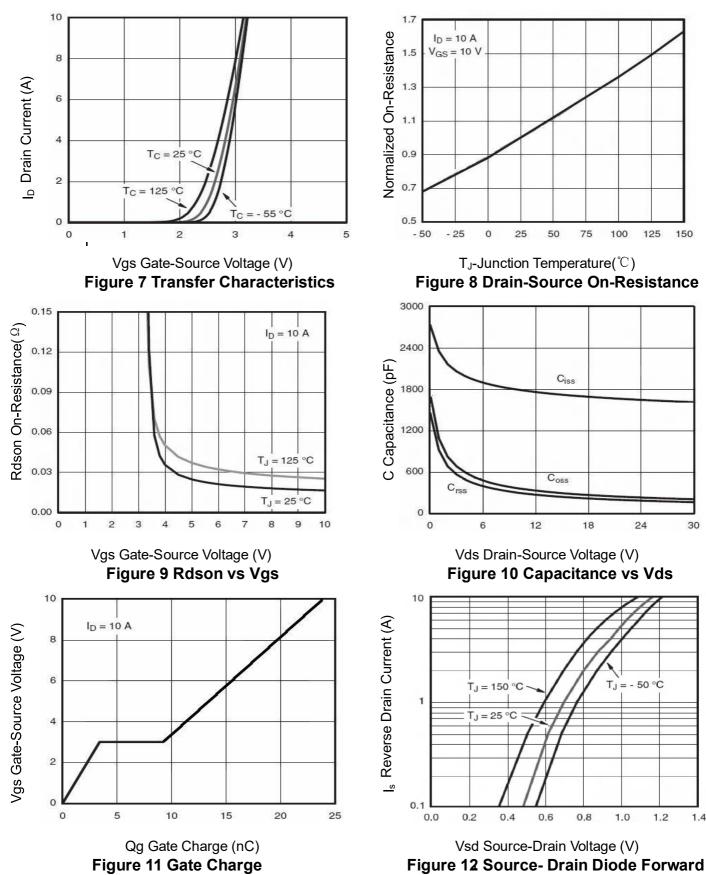


Figure 5 Output Characteristics



150

30

1.4



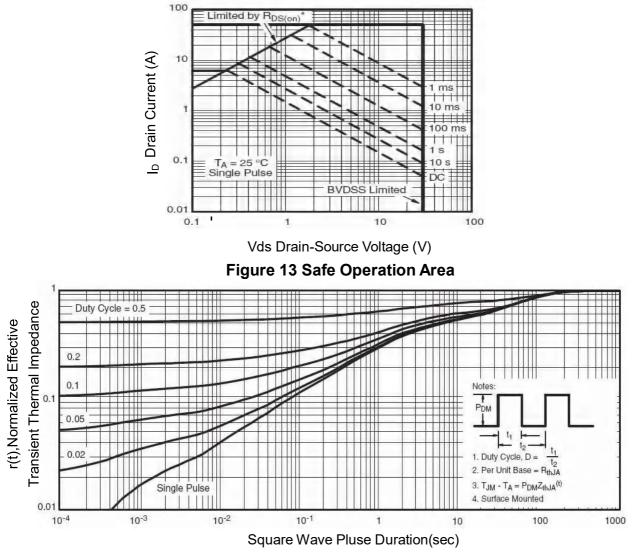
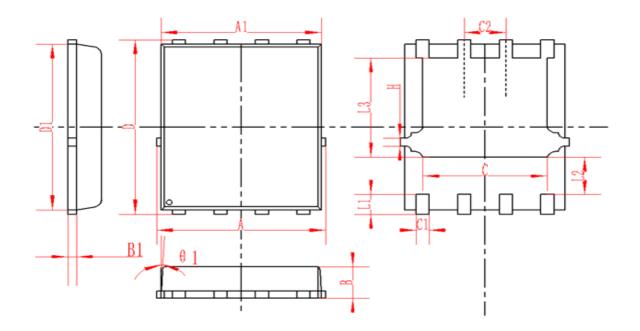


Figure 14 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



SYMBOL		MM			INCH	
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1		0.254REF			0.010REF	
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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